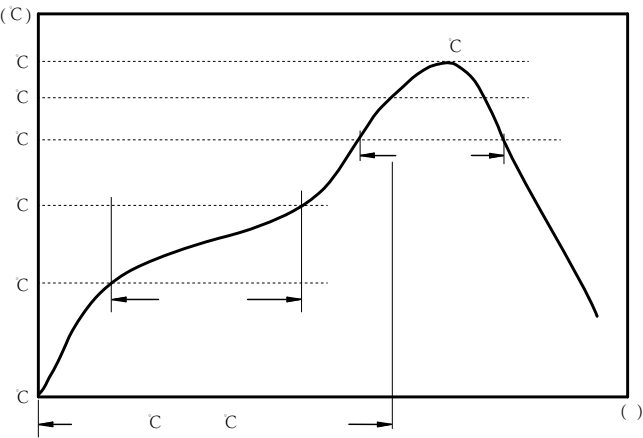
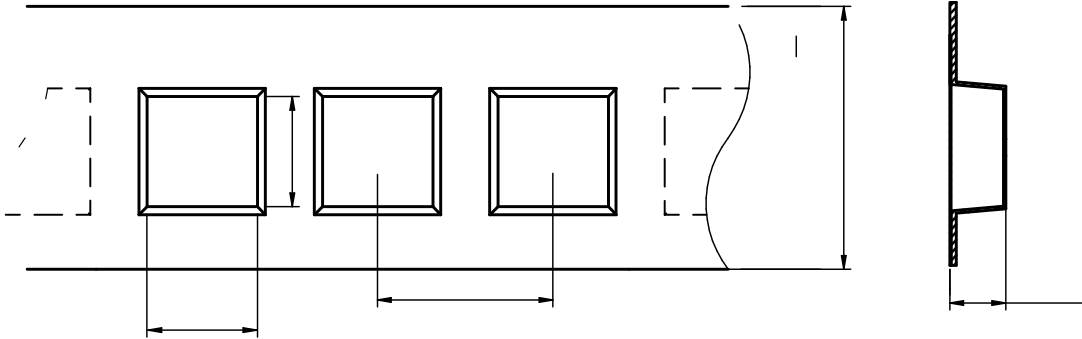






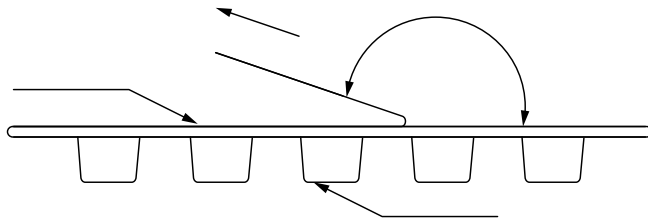
C
C
C

:



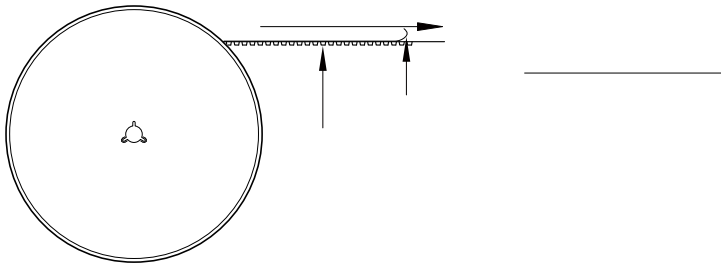
SCM5040	5.3±0.1	5.3±0.1	1.5±0.1	4.0±0.2	12.0±0.1	16.0±0.3	4.6±0.1	1.75±0.1	0.40±0.05

Marking	
---------	--



The peel force of top cover tape shall be between 0.1 to 1.17 N

:



:

- tions (temperature: -5 to 35°C, humidity: 75% RH Max). If the storage period elapses, the soldering of the
- Product should not be exposed to environment with high temperature, high humidity, dust, corrosive gas and
-
-
- Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient
- Before soldering, be sure to preheat components. The preheating temperature should be set so that the
- tions. If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
- Generally, Kohler might not be familiar with either customer's specific application or actual requests as customer performance described in the product specification is suitable for using in customer's particular application or
-
- An open circuit may occur due to mechanical stress from the resin, its amount, cured shape, or operating
-
- Prior to using the coating resin, please verify that no reliability issues are observed.
- When applying conformal coating for product protection, materials with a high shrinkage rate should be avoided. If such materials must be used, it is recommended to apply silicone around the inductor core in a closed loop to prevent the conformal coating from flowing into or penetrating the windings, thereby avoiding open-circuit failures caused by the coating's thermal stress.